INTEGRATED CIRCUITS

DATA SHEET

TEA5570RF/IF circuit for AM/FM radio

Product specification
File under Integrated Circuits, IC01

September 1987





TEA5570

GENERAL DESCRIPTION

The TEA5570 is a monolithic integrated radio circuit for use in portable receivers and clock radios. The IC is also applicable to mains-fed AM and AM/FM receivers and car radio-receivers. Apart from the AM/FM switch function the IC incorporates for AM a double balanced mixer, 'one-pin' oscillator, i.f. amplifier with a.g.c. and detector, and a level detector for tuning indication. The FM circuitry comprises i.f. stages with a symmetrical limiter for a ratio detector. A level detector for mono/stereo switch information and/or indication complete the FM part.

Features

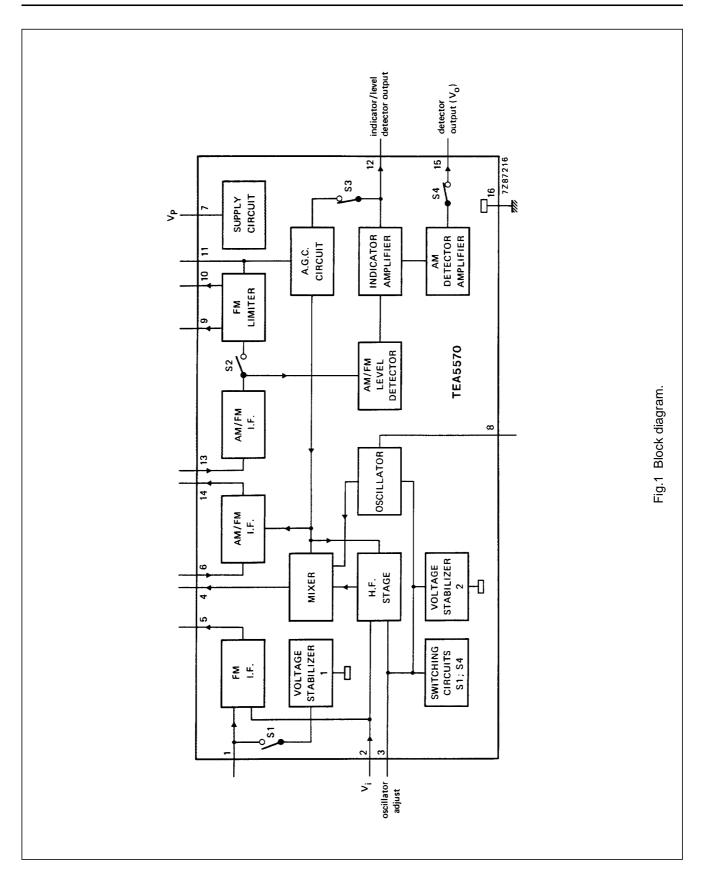
- Simple d.c. switching for AM to FM by only one d.c. contact to ground (no switch contacts in the i.f. channel, a.f. or level detector outputs)
- · AM and FM gain control
- Low current consumption (I_{tot} = 6 mA)
- Low voltage operation (V_P = 2,7 to 9 V)
- · Ability to handle large AM signals; good i.f. suppression
- · Applicable for inductive, capacitive and diode tuning
- Double smoothing of a.g.c. line
- Short-wave range up to 30 MHz
- · Lumped or distributed i.f. selectivity with coil and/or ceramic filters
- · AM and a.g.c. output voltage control
- · Distribution of PCB wiring provides good frequency stability
- Economic design for 'AM only' receivers.

QUICK REFERENCE DATA (at $T_{amb} = 25$ °C)

Supply voltage	V _P = V ₇₋₁₆	typ.	5,4 V
Supply current	l ₇	typ.	6,2 mA
AM performance (pin 2) for $m = 0.3$			
Sensitivity			
at $V_0 = 10 \text{ mV}$	V_{i}	typ.	1,7 μV
at $S/N = 26 dB$	V_{i}	typ.	16 μV
A.F. output voltage at V _i = 1 mV	V_{o}	typ.	100 mV
Total harmonic distortion at V _i = 1 mV	THD	typ.	0,5 %
FM performance (pin 1) for $\Delta f = \pm 22.5$ kHz			
limiting sensitivity, –3 dB	V_{i}	typ.	110 μV
Signal-to-noise ratio for $V_i = 1 \text{ mV}$	S/N	typ.	65 dB
A.F. output voltage at $V_i = 1 \text{ mV}$	V_{o}	typ.	100 mV
Total harmonic distortion at V _i = 1 mV	THD	typ.	0,3 %
AM suppression at $V_i = 10 \text{ mV}$	AMS	typ.	50 dB

PACKAGE OUTLINE

16-lead DIL; plastic (SOT38); SOT38-1; 1996 July 25.



RF/IF circuit for AM/FM radio

TEA5570

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

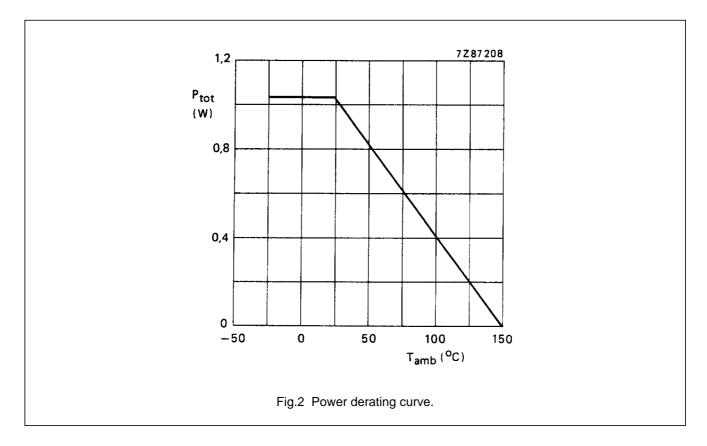
Supply voltage (pin 7) $V_P = V_{7-16} \qquad \text{max.} \qquad 12 \text{ V}$ Voltage at pins 4, 5, 9 and 10 to pin 16 (ground) $V_{n-16} \qquad \text{max.} \qquad 12 \text{ V}$

Voltage range at pin 8 V_{8-16} $V_{P}\pm 0.5 \text{ V}$

Current into pin 5 I_5 max. 3 mA

Total power dissipation $P_{tot} \hspace{1cm} see Fig.2 \\ Storage temperature range \\ T_{stg} \hspace{1cm} -55 \hspace{1cm} to \hspace{1cm} + \hspace{1cm} 150 \hspace{1cm} ^{\circ}C$

Operating ambient temperature range T_{amb} $-30 \text{ to } +85 ^{\circ}\text{C}$



RF/IF circuit for AM/FM radio

TEA5570

D.C. CHARACTERISTICS

 V_P = 6 V; T_{amb} = 25 °C; measured in Fig.10; unless otherwise specified

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply (pin 7)					
Supply voltage (note 1)	$V_P = V_{7-16}$	2,4	5,4	9,0	V
Voltages					
at pin 1 (FM)	V ₁₋₁₆	_	1,42	_	V
at pin 1; -I ₁ = 50 μA (FM)	V ₁₋₁₆	_	1,28	_	V
at pins 2 and 3 (AM)	V _{2,3-16}	_	1,42	_	V
at pin 6	V ₆₋₁₆	_	0,7	_	V
at pin 11	V ₁₁₋₁₆	_	1,4	_	V
at pin 13	V ₁₃₋₁₆	_	0,7	_	V
at pin 14	V ₁₄₋₁₆	_	4,3	_	V
Currents					
Supply current	l ₇	4,2	6,2	8,2	mA
Current supplied from pin 1 (FM)	-I ₁	_	_	50	μΑ
Current supplied from pin 12	-I ₁₂	_	_	20	μΑ
Current supplied from pin 15	-I ₁₅	_	30	_	μΑ
Current into pin 4 (AM)	I ₄	_	0,6	_	mA
Current into pin 5 (FM) (note 4)	I ₅	_	0,35	_	mA
Current into pin 8 (AM)	I ₈	_	0,3	_	mA
Current into pins 9, 10 (FM)	I _{9,10}	_	0,65	_	mA
Current into pin 14	I ₁₄	_	0,4	_	mA
Power consumption	Р	_	40	_	mW

RF/IF circuit for AM/FM radio

TEA5570

A.C. CHARACTERISTICS

AM performance

 $V_P=6~V;~T_{amb}=25~^{\circ}C;~r.f.~condition;~f_i=1~MHz,~m=0,3,~f_m=1~kHz;~transfer~impedance~of~the~i.f.~filter~left (Z_{tr}|=v_6/l_4=2,7~k\Omega;~measured~in~Fig.10;~unless~otherwise~specified~left (Z_{tr}|=v_6/l_4=2,7~k\Omega;~measured~in~Fig.10;~$

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
R.F. sensitivity (pin 2)					
at $V_0 = 30 \text{ mV}$	V _i	3,5	5,0	7,0	μV
at $S + N/N = 6 dB$	V _i	_	1,3		μV
at $S + N/N = 26 \text{ dB}$	V _i	_	16	20	μV
at $S + N/N = 50 dB$	V _i	_	1	_	mV
Signal handling (THD ≤ 10% at m = 0,8)	V _i	200	_	_	mV
A.F. output voltage at V _i = 1 mV	V _o	80	100	125	mV
Total harmonic distortion					
at $V_i = 100 \mu\text{V}$ to 100 mV (m = 0,3)	THD	_	0,5	_	%
at $V_i = 2 \text{ mV } (m = 0.8)$	THD	_	1,0	2,5	%
at $V_i = 200 \text{ mV } (m = 0.8)$	THD	_	4,0	10	%
I.F. suppression at $V_0 = 30 \text{ mV}$ (note 2)	α	26	35	_	dB
Oscillator voltage (pin 8; note 3)					
at f _{osc} = 1455 kHz	V ₈₋₁₆	120	160	200	mV
Indicator current (pin 12) at V _i = 1 mV	I ₁₂	_	200	230	μV

FM performance

 V_P = 6 V; T_{amb} = 25 °C; i.f. condition: f_i = 10,7 MHz, Δf = \pm 22,5 kHz, f_m = 1 kHz; transfer impedance of the i.f. filter $|Z_{tr}|$ = v_6/i_5 = 275 Ω ; measured in Fig.10; unless otherwise specified

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
I.F. part					
I.F. sensitivity (adjustable; note 4)					
Input voltage					
at -3 dB before limiting	V _i	90	110	130	μV
at S + N/N = 26 dB	V _i	_	6	_	μV
at S + N/N = 65 dB	V _i	_	1	_	mV
A.F. output voltage at V _i = 1 mV	Vo	80	100	125	mV
Total harmonic distortion at V _i = 1 mV	THD	_	0,3	_	%
AM suppression (note 5)	AMS	_	50	_	dB

RF/IF circuit for AM/FM radio

TEA5570

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Indicator/level detector (pin 12)					
Indicator current	I ₁₂	_	250	325	μΑ
D.C. output voltage					
at $V_i = 300 \mu\text{V}$	V ₁₂₋₁₆	_	0,25	_	V
at $V_i = 2 \text{ mV}$	V ₁₂₋₁₆	_	1,0	_	V
AM to FM switch					
Switching current at V ₃₋₁₆ < 1 V	-l ₃	_	_	400	μΑ

Notes to the characteristics

- 1. Oscillator operates at $V_{7-16} > 2,25 \text{ V}$.
- I.F. suppression is defined as the ratio α = 20 log V_{i1} V_{i2} where: V_{i1} is the input voltage at f = 455 kHz and V_{i2} is the input voltage at f = 1 MHz.
- 3. Oscillator voltage at pin 8 can be preset by Rosc (see Fig.10).
- 4. Maximum current into pin 5 can be adjusted by R1 (see Fig.10); $I_5 = \frac{V_{3-16}}{R1} I_3$ when $V_{3-16} = 800$ mv; $I_3 = 400$ μ A.
- 5. AM suppression is measured with f_m = 1 kHz, m = 0,3 for AM; f_m = 400 Hz, Δf = \pm 22,5 kHz for FM.

COMPONENT

R7, R11

R7

Facility adaptation

AM output voltage

AM a.g.c. setting

FACILITY

Facility adaptation is achieved as follows (see Fig.10):

FM sensitivity	R1 fixes the current at pin 5 ($I_5 = \frac{V_{3-16}}{R1} - 400 \mu A$)
	(gain adjustable \pm 10 dB; see note 4)
AM sensitivity	R11 and coil tapping
AM oscillator biasing	R _{osc}

RF/IF circuit for AM/FM radio

TEA5570

Typical graphs

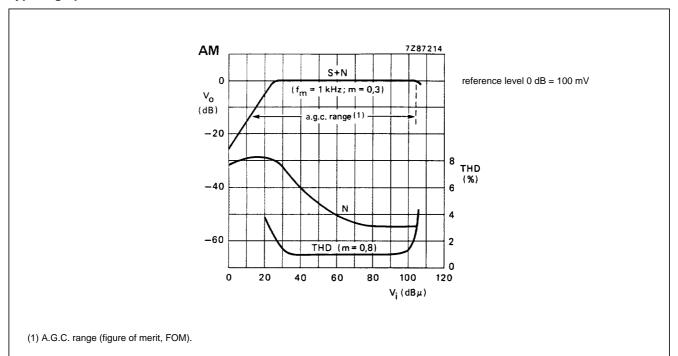
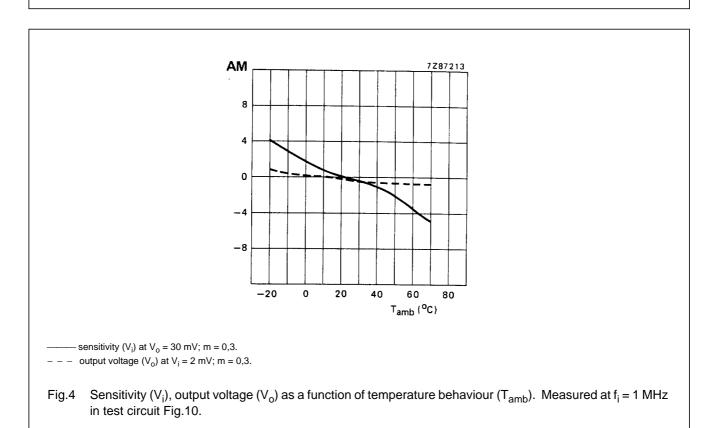
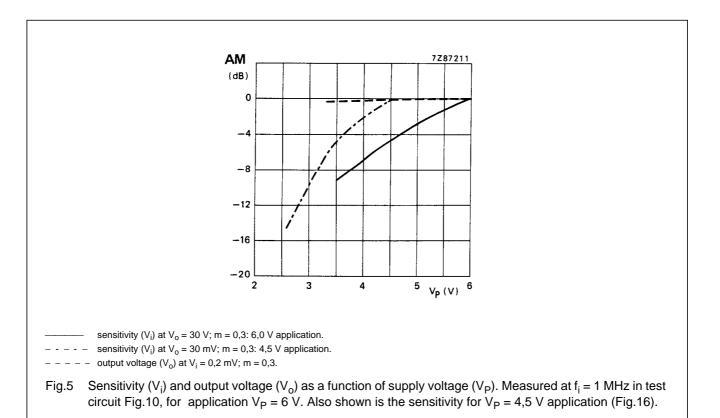


Fig.3 Signal, noise and distortion as a function of input voltage (V_i) . Measured at $f_i = 1$ MHz in test circuit Fig.10.

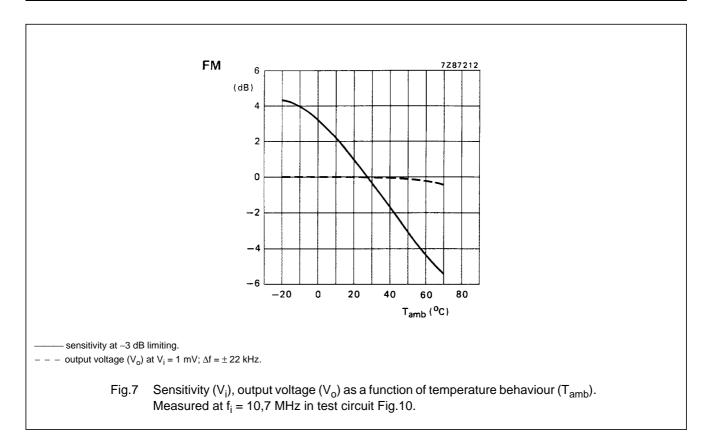


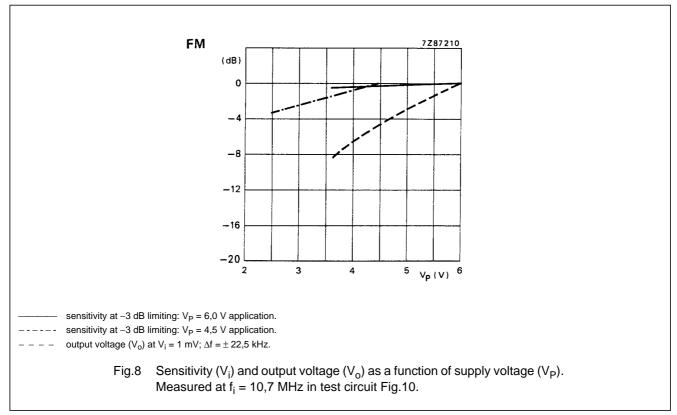
RF/IF circuit for AM/FM radio



FM 7Z87215 reference level 0 dB = 100 mV S+N 0 $(\Delta f = \pm 22,5 \text{ kHz})$ V_o (dB) -20 THD (%) 4 THD -60 2 $(\Delta f =$ ± 22,5 kHz) V_i (dBμ) 120 0 40 Signal, noise and distortion as a function of input voltage (V_i) . Measured at $f_i = 10.7$ MHz Fig.6 in test circuit Fig.10.

RF/IF circuit for AM/FM radio





RF/IF circuit for AM/FM radio

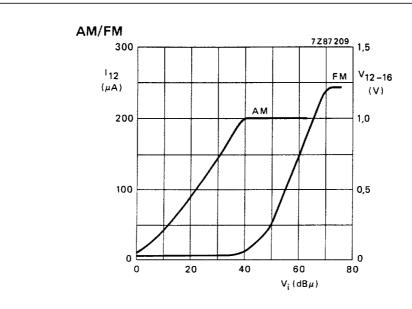
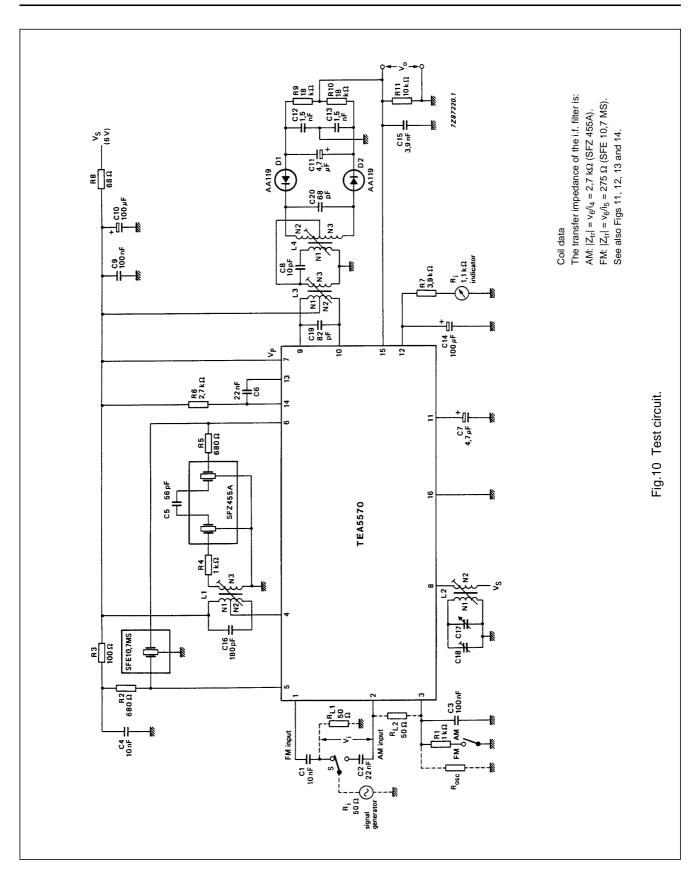


Fig.9 Indicator output current (I_{12}) and d.c. output voltage (V_{12-16}): AM f_i = 1 MHz; FM f_i = 10,7 MHz as a function of input voltage (V_i). Measured in Fig.10; V_P = 6 V; R_{12-16} = 5 k Ω .

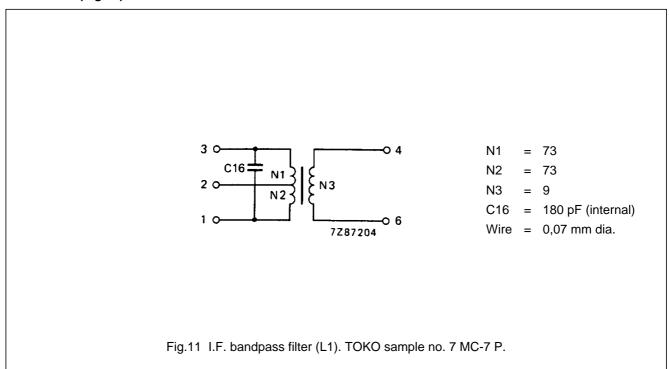


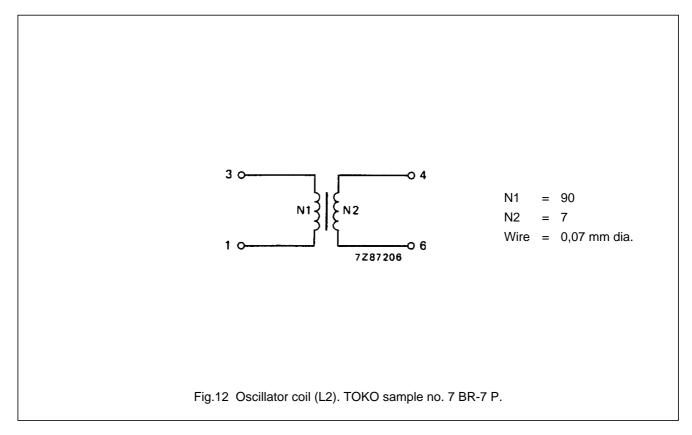
RF/IF circuit for AM/FM radio

TEA5570

COIL DATA

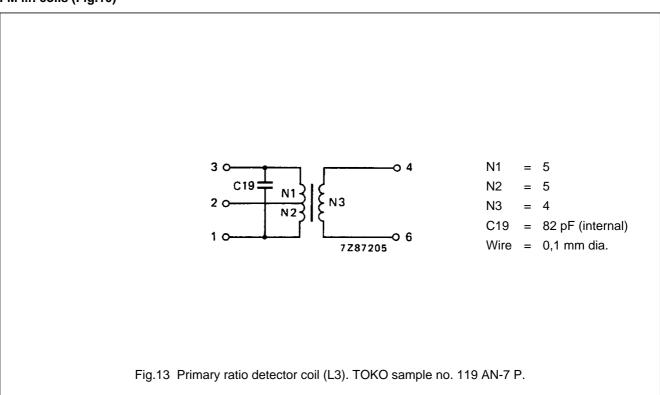
AM i.f. coils (Fig.10)

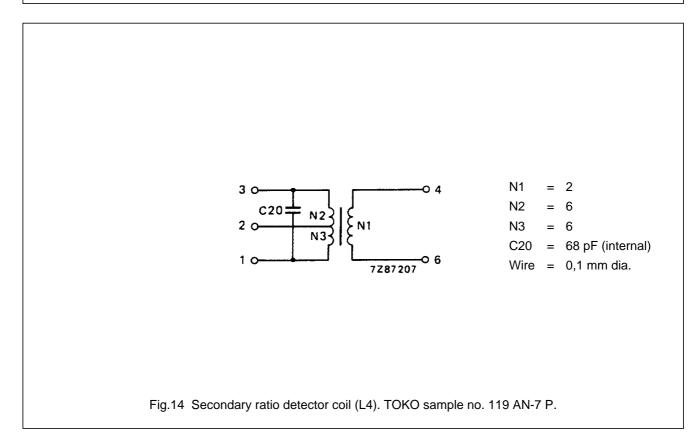




TEA5570

FM i.f. coils (Fig.10)

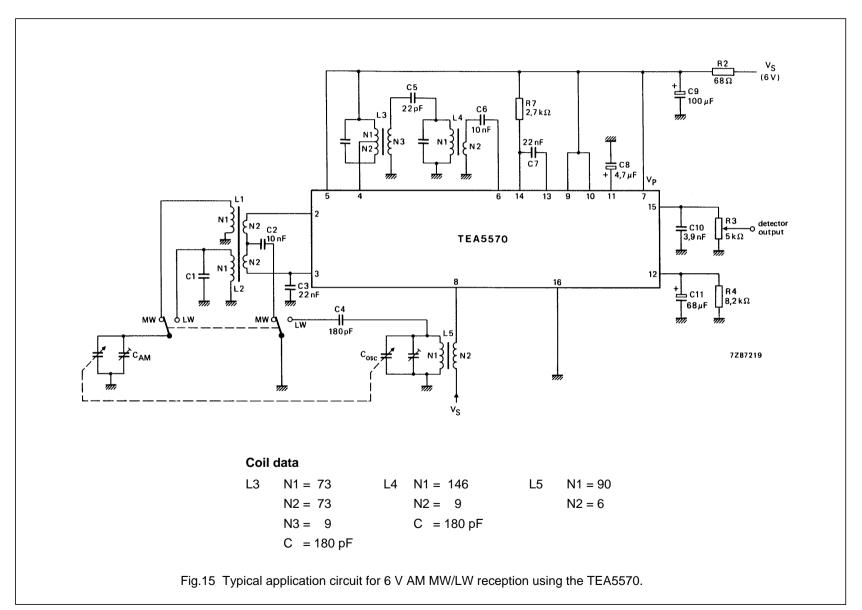


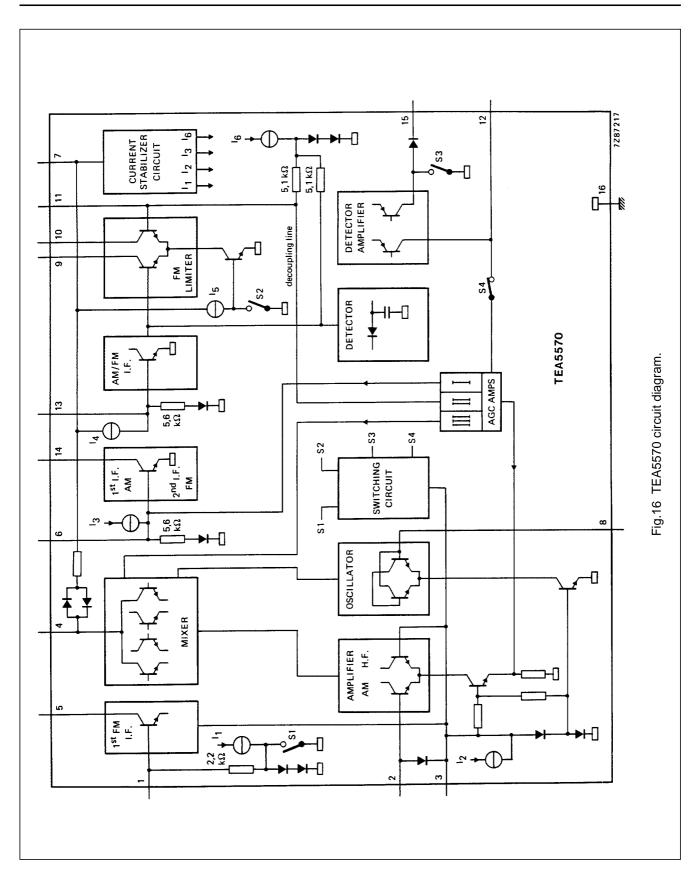


TEA5570

APPLICATION INFORMATION

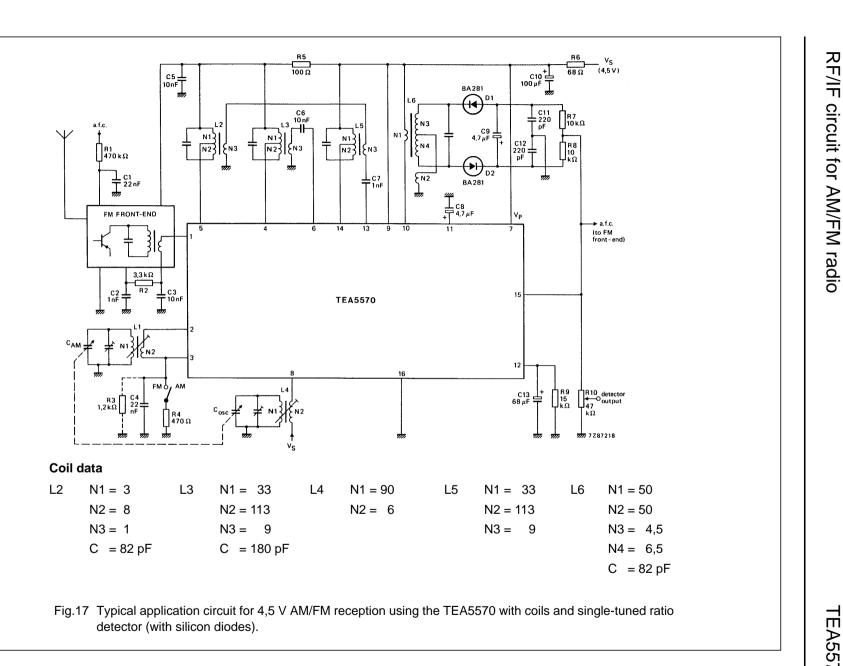
Figs 15 and 17 show the circuit diagrams for the application of 6 V AM MW/LW and 4,5 V AM/FM channels respectively, using the TEA5570. Fig.16 shows the circuitry of the TEA5570.





Product specification

Philips Semiconductors

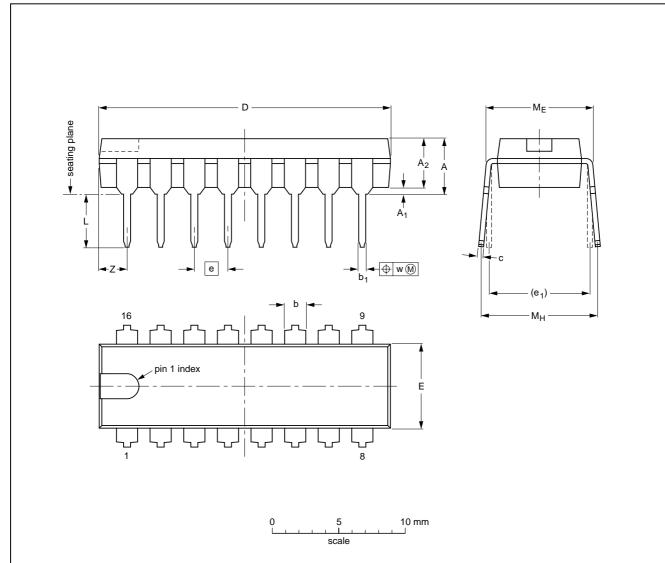


TEA5570

PACKAGE OUTLINE

DIP16: plastic dual in-line package; 16 leads (300 mil); long body

SOT38-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	M _E	Мн	w	Z ⁽¹⁾ max.
mm	4.7	0.51	3.7	1.40 1.14	0.53 0.38	0.32 0.23	21.8 21.4	6.48 6.20	2.54	7.62	3.9 3.4	8.25 7.80	9.5 8.3	0.254	2.2
inches	0.19	0.020	0.15	0.055 0.045	0.021 0.015	0.013 0.009	0.86 0.84	0.26 0.24	0.10	0.30	0.15 0.13	0.32 0.31	0.37 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

	OUTLINE		REFERENCES EUROPEAN ISS				ISSUE DATE
'	VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
	SOT38-1	050G09	MO-001AE				92-10-02 95-01-19

TEA5570

SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature (T_{stg max}). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.